

#### 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

### Qualification Report for PCN# 20120323000 4H Combines C21/C24/C40 HFAB to DFAB Information Only

#### Dear Customer:

Texas Instruments is pleased to announce the completion of qualification testing for the product change described in PCN# 20120323000. The details of the qualification results are included in the following pages and are being forwarded to you in response to your inquiry about this PCN.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN\_ww\_admin\_team@list.ti.com).

Sincerely,

PCN Team SC Business Services Phone: +1(214) 480-6037 Fax: +1(214) 480-6659

Texas Instruments, Inc.



# TEXAS INSTRUMENTS 12500 TI Boulevard, MS 8640, Dallas, Texas 75243

## Qualification Report For # 20120323000 4H Combines C21/C24/C40 HFAB to DFAB

	Qualification Data (Approved: 1/23/2013)							
This qualification has	been deve	loped	for the validation of	of this change.	The quali	fication (	data will	
validate that the proposed change meets the applicable released technical specifications.								
Qual Vehicle 1: PCF8575DB								
Wafer Fab Site:	DFAB		Metallization:	TiW/AlCu 0.59	%			
Wafer Fab Process:	C21		Wafer Diameter:	200mm				
Qualification:	Plan 🛚	Test	Results					
Reliability Test		Conditions			Sample Size/Fails			
Reliability Test		Conditions			Lot#1	Lot#2	Lot#3	
Life Test	Life Test		150C (300Hrs)			77/0	77/0	
Electrical Characterization		(full temperature range, all datasheet parameters)			Pass	Pass	Pass	
**High Temp. Storag	**High Temp. Storage Bake		150C (500 Hrs)			77/0	77/0	
**Biased HAST		130C/85%RH (96 Hrs)			77/0	77/0	77/0	
**Autoclave 121C			121C, 2 atm (96 Hrs)			77/0	77/0	
**T/C -55C/+125C		-55C/+125C (500 Cycles)			77/0	77/0	77/0	
ESD CDM		250V			3/0	3/0	3/0	
ESD HBM		1000V			3/0	3/0	3/0	
Wafer level Reliability			Per Site Specification			-	-	
Latch-up		( per JESD78 )			6/0	6/0	6/0	
Manufacturability (Assembly)		(per mfg. Site specification)			Pass	-	-	
**Preconditioning: Lo				,		L	I	
	Qual Vehicle 2: SMJ320C40GFM50							
Wafer Fab Site: DFAB		Metallization: TiW/AlCu 0.5			%			
Wafer Fab Process: C21		Wafer Diameter: 200mm						
Qualification:	Plan 🛛	Test	Results					
		C	diki a a		Samı	ole Size/	Fails	
Reliability Test		Conditions			Lot#1	Lot#2	Lot#3	
Life Test			125C (1000 Hrs)			-	-	
Electrical Characterization			-			-	-	
Manufacturability (Assembly)		(per mfg. Site specification)			Pass	-	-	
Qual Vehicle 3: TL16C550CFN								
Wafer Fab Site: DFAB Metallization: TiW/AlCu 0.5%								
Wafer Fab Process:	C40	Wafer Diameter: 200mm						
Qualification:	Plan 🛚	Test	Results					
Reliability Test		Conditions			Sample Size/Fails Lot#1 Lot#2 Lot#3			
Electrical Characterization		(full temperature range, all datasheet parameters)			Pass	Pass	Pass	
**T/C -55C/+125C		-55C/+125C (500 Cycles)			77/0	77/0	77/0	

ESD CDM		250V			3/0	3/0	3/0	
ESD HBM		1000V			3/0	3/0	3/0	
Latch-up		( per JESD78 )			6/0	6/0	6/0	
Manufacturability (Assembly)		(per mfg. Site specification)			Pass	-	-	
**Preconditioning: Level 3-2600								
Qual Vehicle 4: TL16C750FN								
Wafer Fab Site: DFAB		Metallization: TiW/AlCu 0.5			%			
Wafer Fab Process: C24		Wafer Diameter: 200mm						
Qualification:	Plan 🖂	Tes	t Results					
Reliability Test		Conditions			Samp Lot#1	le Size/ Lot#2	Fails Lot#3	
Electrical Characterization			(full temperature range, all datasheet parameters)			Pass	Pass	
**T/C -55C/+125C		-55C/+125C (500 Cycles)			77/0	77/0	77/0	
ESD CDM		250V			3/0	3/0	3/0	
ESD HBM		1000V			3/0	3/0	3/0	
Latch-up		( per JESD78 )			6/0	6/0	6/0	
Manufacturability (Assembly)		(per mfg. Site specification)			Pass	-	-	
**Preconditioning: Level 3-260C								
Qual Vehicle 5: PCF8574PWR (MSL Level 1-260C)								
Wafer Fab Site:	er Fab Site: DFAB		Metallization: TiW/AlCu 0.5		%			
Wafer Fab Process: C21		Wafer Diameter: 200mm						
Qualification:	Plan 🖂	Tes	t Results					
Reliability Test		Conditions		Sample Size/Fails Lot#1 Lot#2 Lot#3				
ESD CDM			250V			3/0	3/0	
ESD HBM		1000V			3/0	3/0	3/0	
Latch-up		( per JESD78 )			6/0	6/0	6/0	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com